

SEMITRANS[®] 3

Trench IGBT Modules

SKM600GAL07E3

Features*

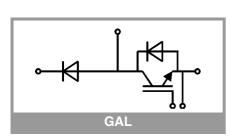
- V_{CE(sat)} with positive temperature coefficient
- High short circuit capability, self limiting to 6 x I_{cnom}
- Fast & soft switching inverse CAL diodes
- Insulated copper baseplate using DCB Technology (Direct Copper Bonding)
- With integrated gate resistor

Typical Applications

- Electronic welders
- DC/DC converter
- Brake chopper
- Switched reluctance motor

Remarks

- Case temperature limited to T_c = 125°C max.
- Recommended $T_{op} = -40 \dots +150^{\circ}C$
- Product reliability results valid for T_j = 150°C
- Use of soft R_G necessary



Absolute	Maximum Rating	s		
Symbol	Conditions		Values	Unit
IGBT				
V _{CES}	T _j = 25 °C		650	V
lc	T 175 %	T _c = 25 °C	852	А
	− T _j = 175 °C	T _c = 80 °C	644	A
I _{Cnom}		-	600	Α
I _{CRM}			1800	Α
V _{GES}			-20 20	V
t _{psc}	$V_{CC} = 360 V$ $V_{GE} \le 15 V$ $V_{CES} \le 650 V$	T _j = 150 °C	6	μs
Tj		_	-40 175	°C
Inverse d	iode		·	
V _{RRM}	T _j = 25 °C		650	V
I _F	T _i = 175 °C	T _c = 25 °C	812	А
	$=1_{j}=175$ C	T _c = 80 °C	595	А
I _{Fnom}			600	А
I _{FRM}			1200	А
I _{FSM}	$t_p = 10 \text{ ms}, \sin 180^\circ, T_j = 25 ^\circ\text{C}$		4320	Α
Tj			-40 175	°C
Freewhee	eling diode			
V _{RRM}	T _j = 25 °C		650	V
l _F	T _i = 175 °C	T _c = 25 °C	812	А
	$1_j = 175 \text{ C}$	T _c = 80 °C	595	А
I _{Fnom}			600	А
I _{FRM}			1200	А
I _{FSM}	t _p = 10 ms, sin 180	°, T _j = 25 °C	4320	А
Tj			-40 175	°C
Module				
I _{t(RMS)}			500	А
T _{stg}	module without TI	N	-40 125	°C
Visol	AC sinus 50 Hz, t =	= 1 min	4000	V

Characte	ristics					
Symbol	Conditions		min.	typ.	max.	Unit
IGBT						
V _{CE(sat)}	$I_{C} = 600 \text{ A}$ $V_{GE} = 15 \text{ V}$ chiplevel	T _j = 25 °C		1.45	1.90	V
		T _j = 150 °C		1.70	2.10	V
V _{CE0}	chiplevel	T _j = 25 °C		0.90	1.00	V
		T _j = 150 °C		0.82	0.90	V
-	V _{GE} = 15 V	T _j = 25 °C		0.92	1.50	mΩ
	chiplevel	T _j = 150 °C		1.47	2.00	mΩ
V _{GE(th)}	$V_{GE}=V_{CE}$, $I_C = 9.6$ mA		5.1	5.8	6.4	V
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 650 \text{ V}, T_{j} = 25 ^{\circ}\text{C}$				0.3	mA
Cies	V _{CE} = 25 V V _{GE} = 0 V	f = 1 MHz		37.0		nF
Coes		f = 1 MHz		2.32		nF
Cres		f = 1 MHz		1.10		nF
Q _G	V _{GE} = - 8 V+ 15 V			4800		nC
R _{Gint}	$T_j = 25 \ ^{\circ}C$			0.5		Ω



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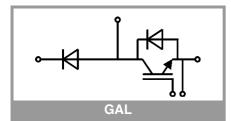
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Symbol	Conditions		min.	tur	mov	Unit
Symbol	Conditions		11111.	typ.	max.	
IGBT	V _{CC} = 300 V	T 150 °C	1	00		
t _{d(on)}	$I_{\rm C} = 600 {\rm A}$	T _j = 150 °C		83		ns
t _r	V _{GE} = +15/-7.5 V	T _j = 150 °C		121		ns
E _{on}	$R_{G on} = 3 \Omega$	T _j = 150 °C		20		mJ
t _{d(off)}	$R_{G off} = 4.3 \Omega$	T _j = 150 °C		1100		ns
t _f	$di/dt_{on} = 4900 \text{ A/}\mu\text{s}$ $di/dt_{off} = 6700 \text{ A/}\mu\text{s}$	$I_j = 150 ^{\circ}C$	1	93		ns
E _{off}	$dv/dt = 1330 V/\mu s$ L _s = 20 nH	T _j = 150 °C		37		mJ
R _{th(j-c)}	per IGBT				0.066	K/W
R _{th(c-s)}	per IGBT (λ _{grease} =0.81 W/(m*K)) 0.033			K/W		
R _{th(c-s)}	per IGBT, pre-applied phase change material			0.02		K/W
Inverse d	iode					
$V_F = V_{EC}$	I _F = 600 A	T _j = 25 °C		1.40	1.76	V
	V _{GE} = 0 V chiplevel	T _j = 150 °C		1.38	1.77	V
V _{F0}	chiplevel	T _j = 25 °C		1.04	1.24	V
		T _j = 150 °C		0.85	0.99	V
r _F	chiplevel	T _j = 25 °C		0.60	0.88	mΩ
		T _j = 150 °C		0.89	1.31	mΩ
I _{RRM}	I _F = 600 A	T _j = 150 °C		390		Α
Q _{rr}	di/dt _{off} = 4940 A/μs V _{GE} = -7.5 V	T _j = 150 °C		54		μC
E _{rr}	$V_{GE} = -7.5 V$ $V_{CC} = 300 V$	T _j = 150 °C		9.1		mJ
R _{th(j-c)}	per diode				0.096	K/W
R _{th(c-s)}	per diode (λ _{grease} =0	.81 W/(m*K))		0.038		K/W
R _{th(c-s)}	per diode, pre-applied phase change material			0.028		K/W
Freewhee	ling diode					
$V_F = V_{EC}$	I _F = 600 A	T _i = 25 °C		1.40	1.76	V
	V _{GE} = 0 V chiplevel	T _j = 150 °C		1.38	1.77	V
V _{F0}	chiplevel	T _j = 25 °C		1.04	1.24	V
		T _j = 150 °C		0.85	0.99	V
r _F	chiplevel	T _j = 25 °C		0.60	0.88	mΩ
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I _{RRM}	$I_{\rm F} = 600 {\rm A}$	T _j = 150 °C		390		Α
Q _{rr}	di/dt _{off} = 4940 A/μs V _{GE} = -7.5 V	T _j = 150 °C		54		μC
Err	$V_{GE} = -7.5 V$ $V_{CC} = 300 V$	T _j = 150 °C		9.1		mJ
R _{th(j-c)}	per diode				0.096	K/W
R _{th(c-s)}	per diode (λ_{grease} =0.81 W/(m*K))			0.038		K/W
R _{th(c-s)}	per diode, pre-applied phase change material			0.028		K/W





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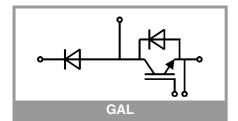
Typical Applications

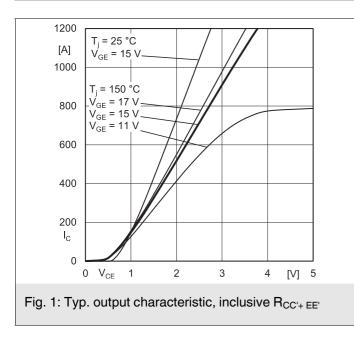
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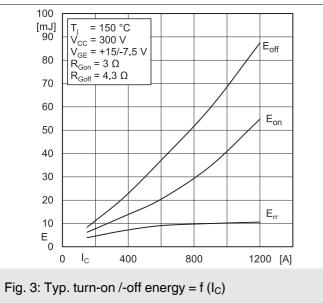
Remarks

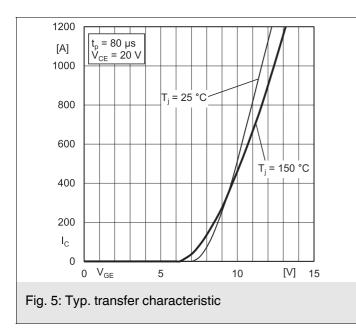
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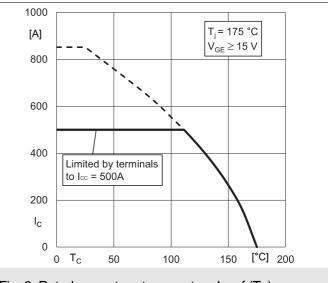
	1		1 .			1
Symbol	Conditions		min.	typ.	max.	Unit
Module						
L _{CE}				15		nH
R _{CC'+EE'}	measured per switch	T _C = 25 °C	0.55			mΩ
		T _C = 125 °C	0.85			mΩ
R _{th(c-s)1}	calculated without	thermal coupling		0.0177		K/W
R _{th(c-s)2}	including thermal c T _s underneath moc $(\lambda_{grease}=0.81 \text{ W/(m}))$	n module 0.018			K/W	
R _{th(c-s)2}	including thermal coupling, T _s underneath module, pre-applied phase change material			0.012		K/W
Ms	to heat sink M6		3		5	Nm
M _t		to terminals M6	2.5		5	Nm
						Nm
w			1		325	g

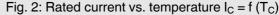


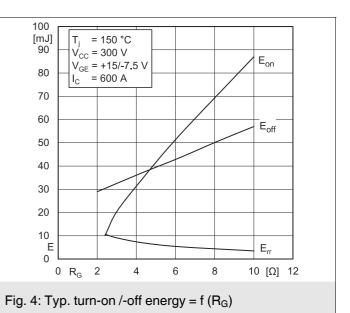


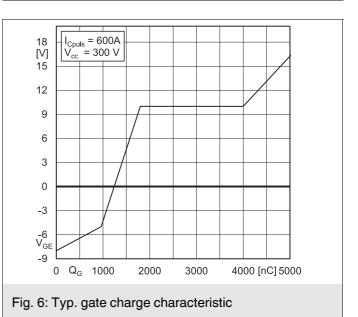




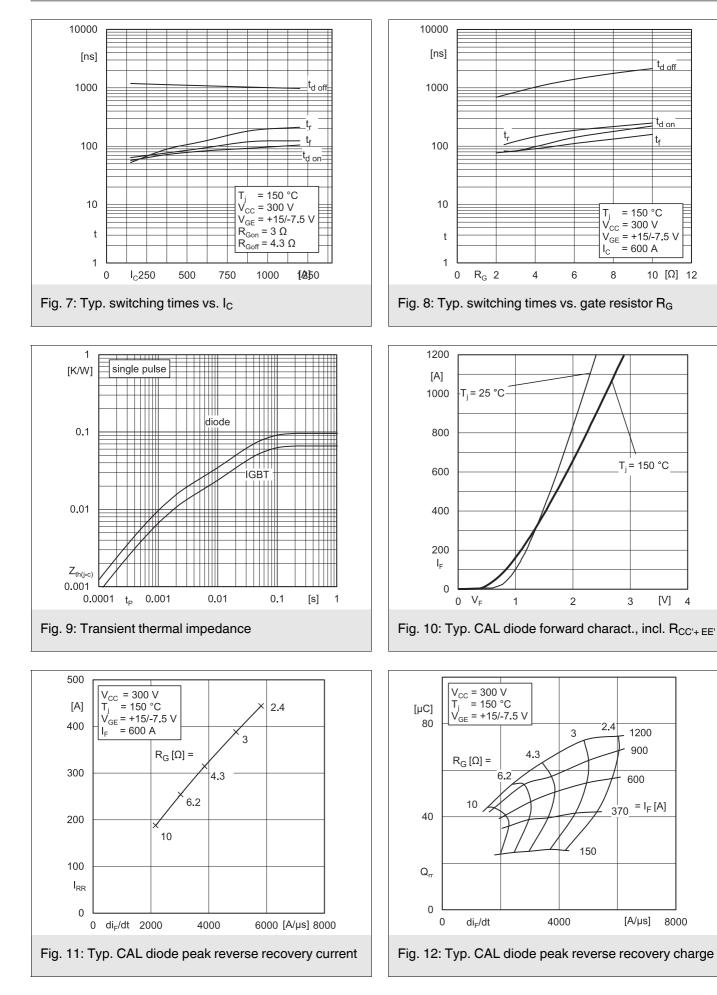








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⁻t_{d off}

t_{d on}

10 [Ω] 12

tf

= 150 °C

T_i = 150 °C

[V]

4

3

1200

900

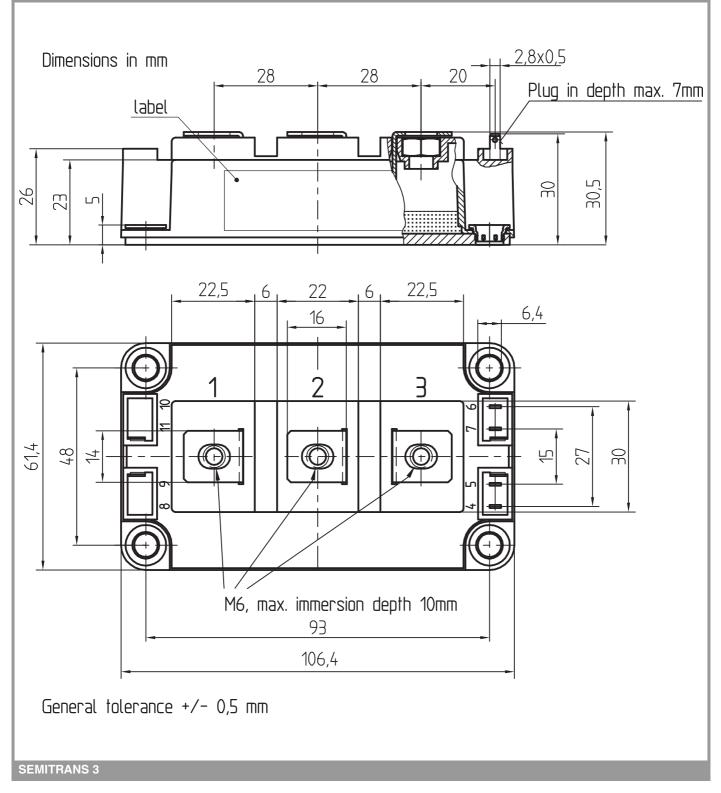
600

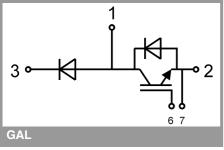
370 = I_F [A]

[A/µs]

8000

8





This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

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